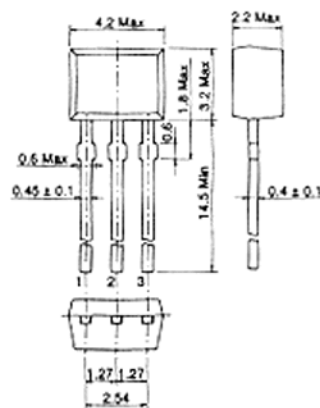


2SK521

SILICON N-CHANNEL JUNCTION FET
VHF AMPLIFIER, MIXER, LOCAL OSCILLATOR



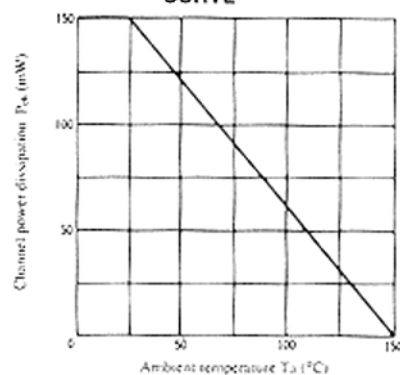
1. Gate
 2. Source
 3. Drain
- (Dimensions in mm)

(SPAK)

■ ABSOLUTE MAXIMUM RATINGS (T_a=25°C)

Item	Symbol	2SK521	Unit
Gate to drain voltage	V _{GD0}	-18	V
Gate current	I _G	10	mA
Drain current	I _D	20	mA
Channel power dissipation	P _{ch}	150	mW
Channel temperature	T _{ch}	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

MAXIMUM CHANNEL DISSIPATION CURVE



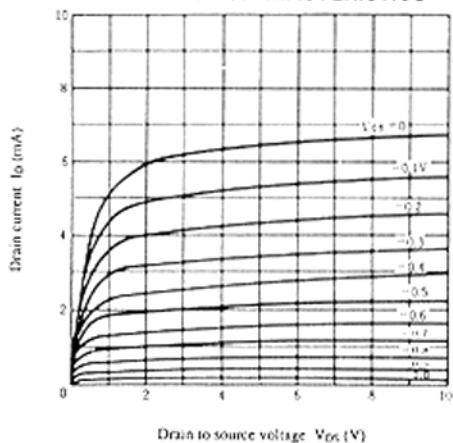
■ ELECTRICAL CHARACTERISTICS (T_a=25°C)

Item	Symbol	Test Condition	min.	typ.	max.	Unit
Gate to drain breakdown voltage	V _{(BR)GDO}	I _G = -100μA, I _S = 0	-18	—	—	V
Gate cutoff current	I _{GSS}	V _{GS} = -0.5V, V _{DS} = 0	—	—	-10	nA
Drain current	I _{DSS} *	V _{DS} = 10V, V _{GS} = 0	2	—	14	mA
Gate to source cutoff voltage	V _{GS(off)}	V _{DS} = 10V, I _D = 10μA	-0.3	—	-5.5	V
Forward transfer admittance	y _{fs}	V _{DS} = 10V, V _{GS} = 0, f = 1kHz	3	8	—	mS
Input capacitance	C _{is}	V _{DS} = 10V, V _{GS} = 0, f = 1MHz	—	3	—	pF
Reverse transfer capacitance	C _{rs}		—	0.4	0.6	pF
Power gain	PG	V _{DD} = 10V, R _S = 33Ω, f = 100MHz	—	18	—	dB
Noise figure	NF		—	2	3.5	dB

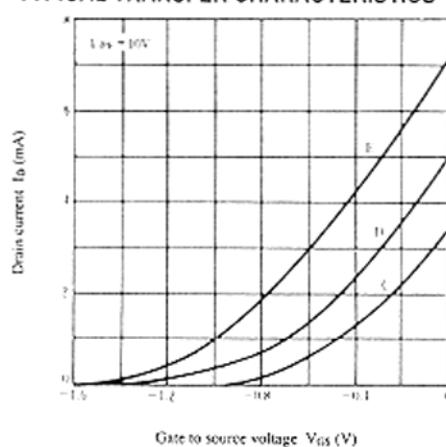
* The 2SK521 is grouped by I_{DSS} as follows.

C	D	E
2 to 5	3 to 7	6 to 14

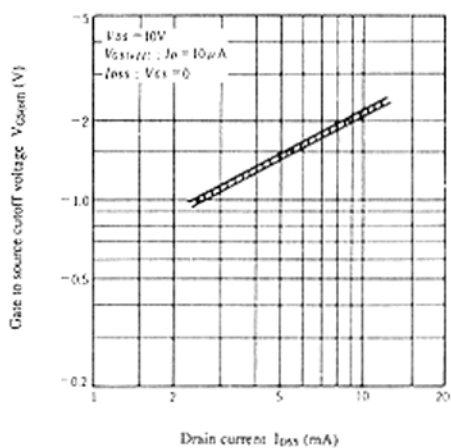
TYPICAL OUTPUT CHARACTERISTICS



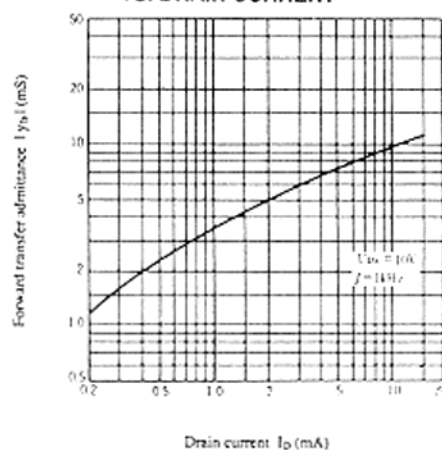
TYPICAL TRANSFER CHARACTERISTICS



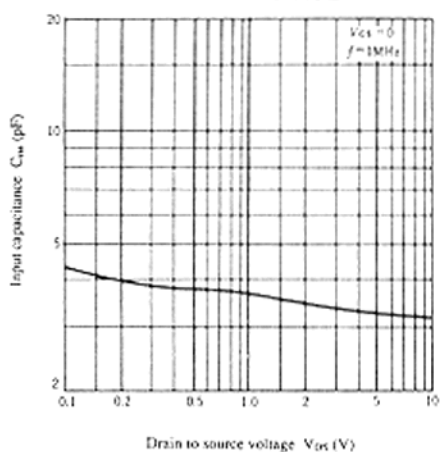
GATE TO SOURCE CUTOFF VOLTAGE VS. DRAIN CURRENT



FORWARD TRANSFER ADMITTANCE VS. DRAIN CURRENT



INPUT CAPACITANCE VS. DRAIN TO SOURCE VOLTAGE



REVERSE TRANSFER CAPACITANCE VS. DRAIN TO SOURCE VOLTAGE

